

Vishay Siliconix

Dual P-Channel 60-V (D-S) 175° MOSFET

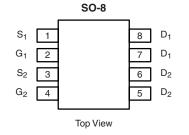
| PRODUCT SUMMARY | | | | |
|---------------------|------------------------------------|--------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | | |
| - 60 | 0.120 at V _{GS} = - 10 V | - 3.1 | | |
| | 0.150 at V _{GS} = - 4.5 V | - 2.8 | | |

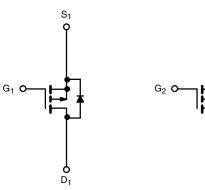
FEATURES

- Halogen-free According to IEC 61249-2-21 • Definition
- TrenchFET[®] Power MOSFET •
- Compliant to RoHS Directive 2002/95/EC •



FREE Available





P-Channel MOSFET



P-Channel MOSFET

 S_2 \sim

Ordering Information: Si4948BEY-T1-E3 (Lead (Pb)-free) Si4948BEY-T1-GE3 (Lead (Pb)-free and Halogen-free)

| ABSOLUTE MAXIMUM RATINGS $T_A = 25 \degree C$, unless otherwise noted | | | | | |
|---|------------------------|-----------------------------------|----------|--------------|------|
| Parameter | | Symbol | 10 s | Steady State | Unit |
| Drain-Source Voltage | | V _{DS} | - 60 | | V |
| Gate-Source Voltage | | V _{GS} | ± 20 | | v |
| | T _A = 25 °C | I | - 3.1 | - 2.4 | |
| Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$ | T _A = 70 °C | I _D | - 2.6 | - 2.0 | |
| Pulsed Drain Current (10 µs Pulse Width) | | I _{DM} | - 25 | | А |
| Continuous Source Current (Diode Conduction) ^a | | ۱ _S | - 2 | - 1.1 | |
| Avalanche Current | L = 0.1 mH | I _{AS} | 15 11 | | |
| Single Pulse Avalanche Energy | | E _{AS} | | | mJ |
| | T _A = 25 °C | PD | 2.4 | 1.4 | W |
| Maximum Power Dissipation ^a | T _A = 70 °C | | 1.7 | 0.95 | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 | to 175 | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|---------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Mauinauna lugation to Anabianta | t ≤ 10 s | - R _{thJA} | 53 | 62.5 | °C/W |
| Maximum Junction-to-Ambient ^a | Steady State | | 85 | 110 | |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 30 | 37 | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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| SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted | | | | | | | |
|--|---------------------|--|------|-------|-------|------|--|
| Parameter | Symbol | Test Conditions Min. | | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ | - 1 | | - 3 | V | |
| Gate-Body Leakage | I _{GSS} | | | | ± 100 | nA | |
| Zara Cata Valtaga Drain Current | 1 | $V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | - 1 | | |
| Zero Gate Voltage Drain Current | IDSS | V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 70 °C | | | - 10 | μΑ | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = - 5 V, V _{GS} = - 10 V | - 25 | | | А | |
| | Б | V _{GS} = - 10 V, I _D = - 3.1 A | | 0.100 | 0.120 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -0.2 \text{ A}$ | | 0.126 | 0.150 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 3.1 A | | 8.5 | | S | |
| Diode Forward Voltage ^a | V _{SD} | I _S = - 2 A, V _{GS} = 0 V | | - 0.8 | - 1.2 | V | |
| Dynamic ^b | | | | | | | |
| Total Gate Charge | Qg | | | 14.5 | 22 | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = - 30 V, V_{GS} = - 10 V, I_{D} = - 3.1 A | | 2.2 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | 3.7 | | | |
| Gate Resistance | R _g | f = 1 MHz | | 14 | | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | | |
| Rise Time | t _r | V_{DD} = - 30 V, R_L = 30 Ω | | 15 | 22 | | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_{\text{D}}\cong$ - 1 A, V_{GEN} = - 10 V, R_{g} = 6 Ω | | 50 | 75 | ns | |
| Fall Time | t _f | | | 35 | 55 | | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = - 2 A, dl/dt = 100 A/μs | | 30 | 50 | | |

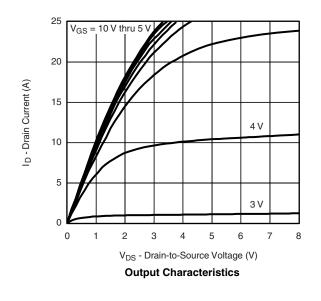
Notes:

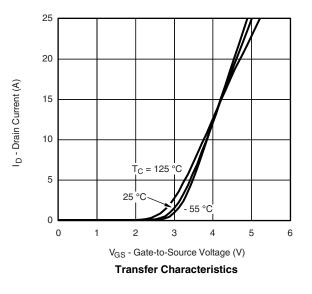
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



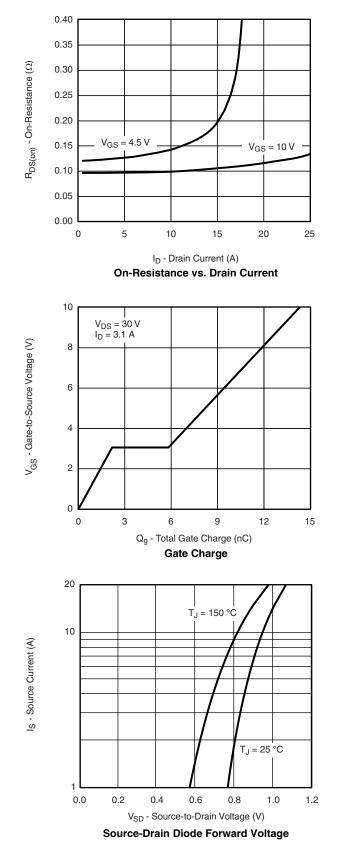


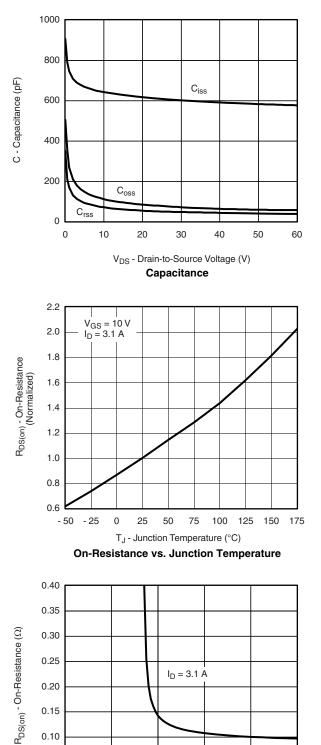


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





0.10

0.05 0.00

0

2

4

6

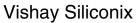
V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage

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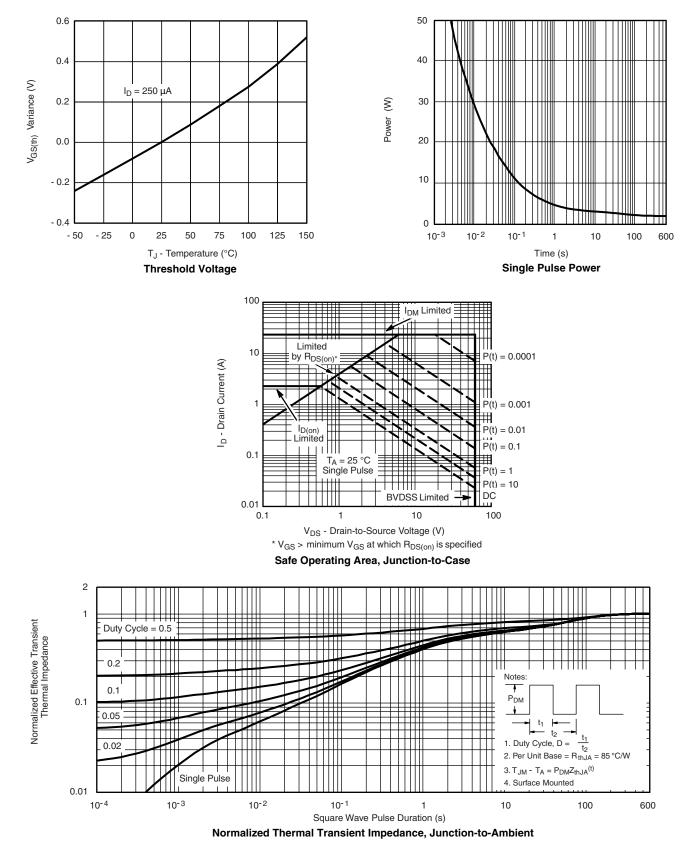
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Si4948BEY





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

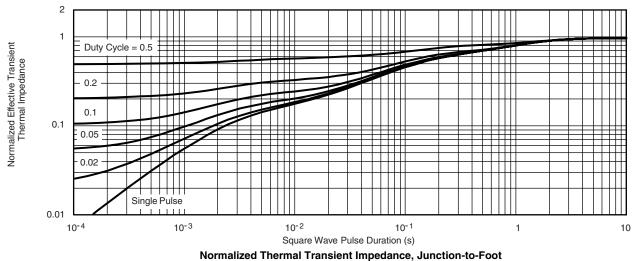




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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-10-1 oot

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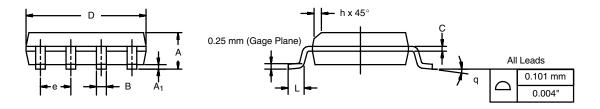


Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





| | MILLIM | IETERS | INCHES | | | |
|---|--------|--------|-----------|-------|--|--|
| DIM | Min | Мах | Min | Max | | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 BSC | | | |
| н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | | |

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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